

**BP2802EB****High Isolation Voltage DC Input Response Type  
SSOP Photo Coupler**

**RoHS**  
COMPLIANT



- **Features:**

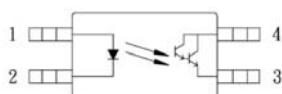
1. High current transfer ratio (CTR=2000%TYP.@ IF=1 mA, VCE=2V ).
2. Small and thin package(4pin SOP, Pin pitch 1.27mm).
3. High isolation voltage between input and output ( Viso : 3750Vrms ).

- **Application :**

1. Hybrid substrates that require high density mounting.
2. Programmable logic controllers.
3. Communications, Telephone, etc.
3. Measuring instruments.

- **Internal Connection Diagram :**

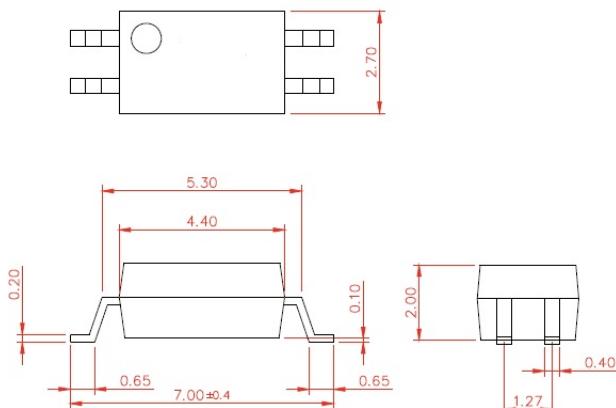
Top View



1. Anode
2. Cathode
3. Emitter
4. Collector

- **Outline Dimensions :** (Unit : mm)

BP2802EB

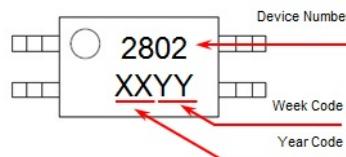


- Classification table of current transfer ratio is shown below.

T<sub>a</sub>=25°C

Model No.	CTR Rank	CTR ( % )
BP2802EB	E Rank	200~9000

**Notes:**



**TOLERANCE : ±0.2mm**

## ● Absolute Maximum Ratings

Ta=25°C

Parameter		Symbol	Rating	Unit
Input	Forward current	I <sub>F</sub>	50	mA
	Peak forward current(*1)	I <sub>FP</sub>	1	A
	Reverse voltage	V <sub>R</sub>	6	V
	Power dissipation	P <sub>D</sub>	60	mW
	Power dissipation derating	P <sub>D</sub> /°C	0.6	mW/°C
Output	Collector-emitter voltage	V <sub>C EO</sub>	40	V
	Emitter-collector voltage	V <sub>E CO</sub>	6	V
	Collector current	I <sub>C</sub>	90	mA
	Collector power dissipation	P <sub>C</sub>	120	mW
	Collector power dissipation derating	P <sub>C</sub> /°C	1.2	mW/°C
Isolation voltage 1 minute(*2)		V <sub>ISO</sub>	3750	Vrms
Operating temperature		T <sub>OPR</sub>	-30 to +115	°C
Storage temperature		T <sub>STG</sub>	-55 to +150	°C
Soldering temperature 10 second		T <sub>SOL</sub>	260	°C

\*1 PW=100μs,Duty Cycle=1%.

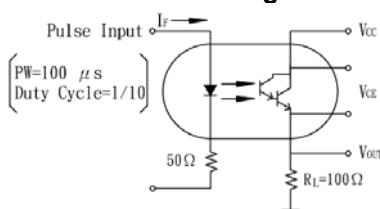
\*2 AC voltage for 1 minute at T =25°C,RH=60% between input and output.

## ● Electro-optical Characteristics

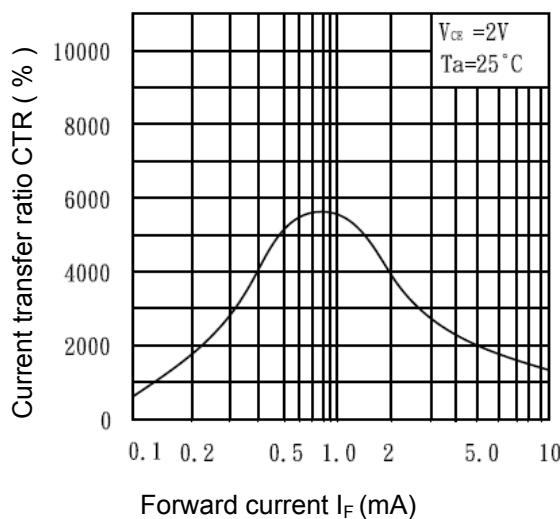
Ta=25°C

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V <sub>F</sub>	I <sub>F</sub> =5mA	—	1.1	1.4	V
	Peak forward voltage	V <sub>FP</sub>	I <sub>FP</sub> =0.5A	—	—	3.0	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> =5V	—	—	5	μA
	Terminal capacitance	C <sub>T</sub>	V=0, f=1MHZ	—	30	—	pF
Output	Collector dark current	I <sub>CEO</sub>	V <sub>C E</sub> =40V,I <sub>F</sub> =0mA	—	—	0.4	μA
Transfer characteristics	Current transfer ratio	CTR	I <sub>F</sub> =1mA,V <sub>C E</sub> =2V	200	—	9000	%
	Collector-emitter saturation voltage	V <sub>C E(sat)</sub>	I <sub>F</sub> =10mA,I <sub>C</sub> =2mA	—	—	1.0	V
	Isolation resistance	R <sub>ISO</sub>	DC500V	5x10 <sup>10</sup>	10 <sup>11</sup>	—	Ω
	Floating capacitance	C <sub>F</sub>	V=0, f=1MHZ	—	0.4	—	pF
Response time (Rise)(*3)		t <sub>r</sub>	V <sub>C E</sub> =5V,I <sub>C</sub> =2mA,R <sub>L</sub> =100Ω	—	200	—	μs
Response time (Fall)(*3)		t <sub>f</sub>	V <sub>C E</sub> =5V,I <sub>C</sub> =2mA,R <sub>L</sub> =100Ω	—	200	—	μs

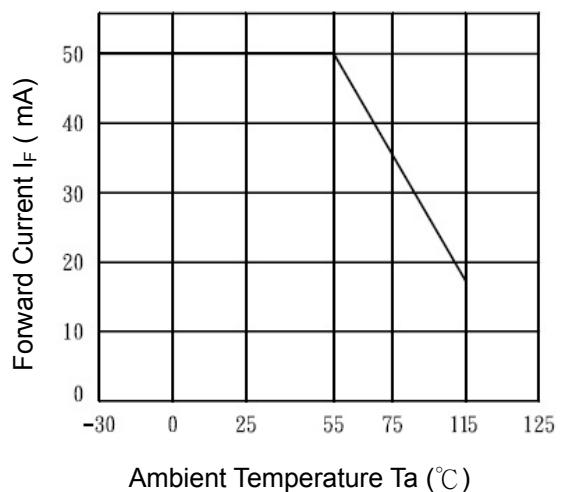
\*3 Test circuit for switching time



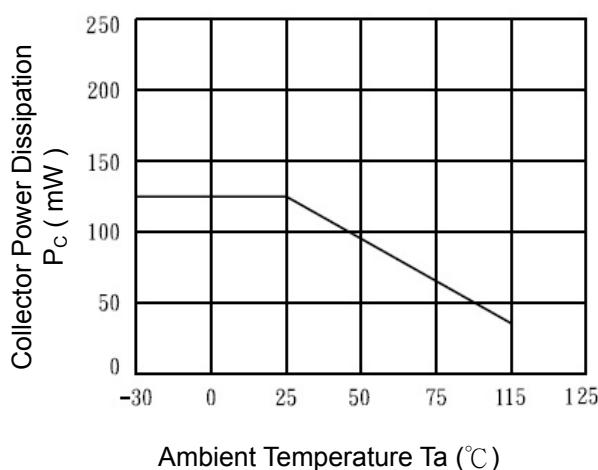
**Fig.1 Current Transfer Ratio vs. Forward Current**



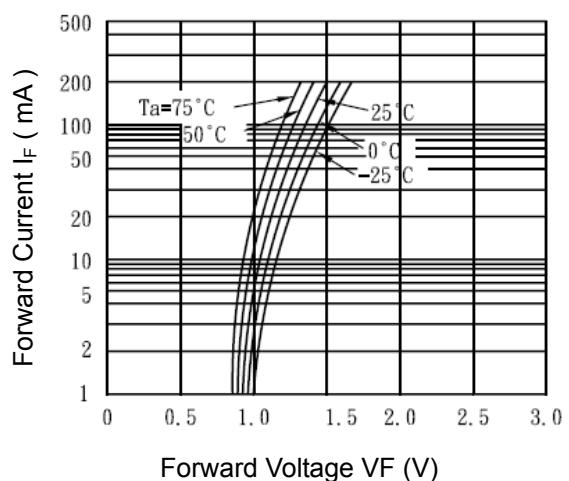
**Fig.2 Forward Current vs. Ambient Temperature**



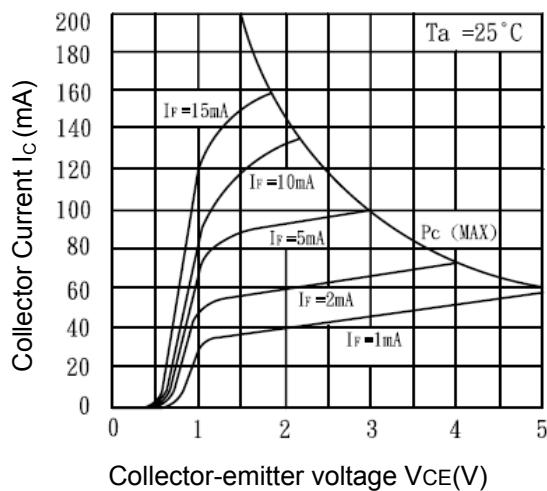
**Fig.3 Collector Power Dissipation vs. Ambient Temperature**



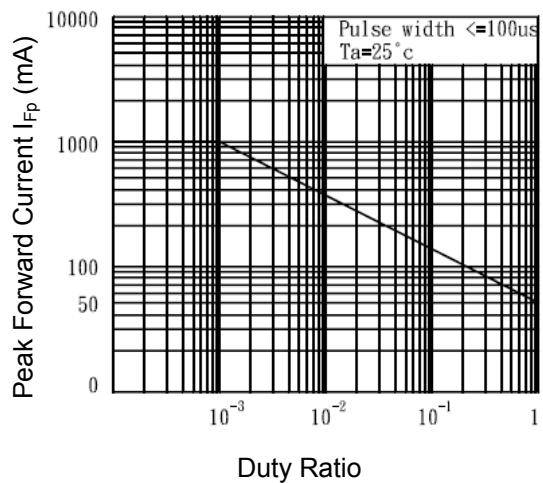
**Fig.4 Forward Current vs. Forward Voltage**



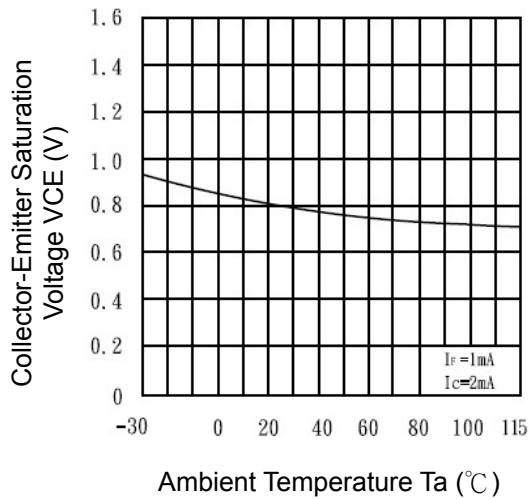
**Fig.5 Collector Current vs. Collector-Emitter Voltage**



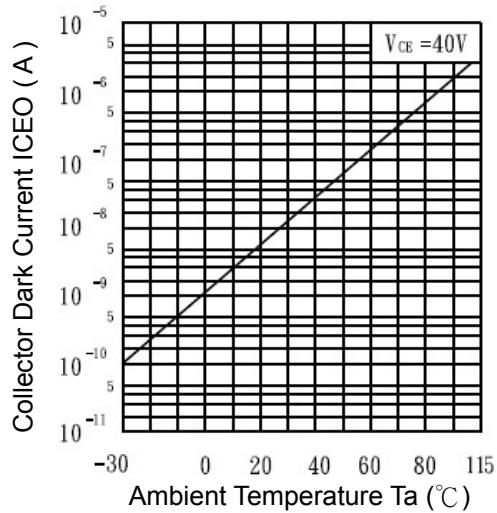
**Fig.6 Peak Forward Current vs. Duty Ratio**



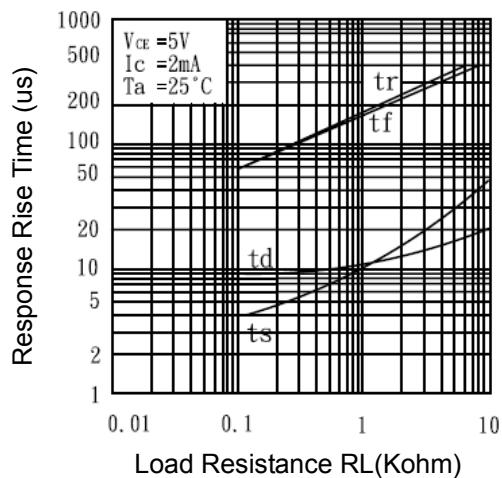
Collector-Emitter Saturation  
Voltage vs. Ambient  
Temperature



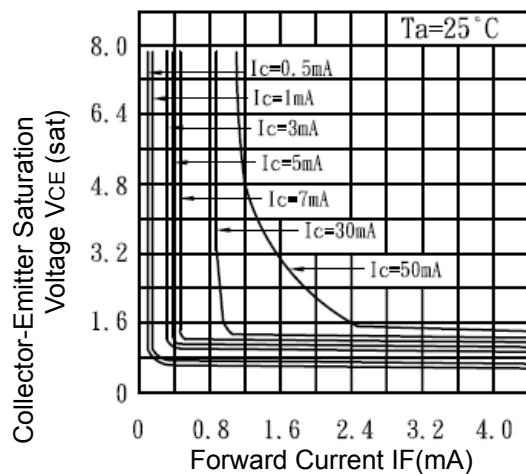
Collector Dark Current  
vs. Ambient Temperature



Response Time  
vs. Load Resistance

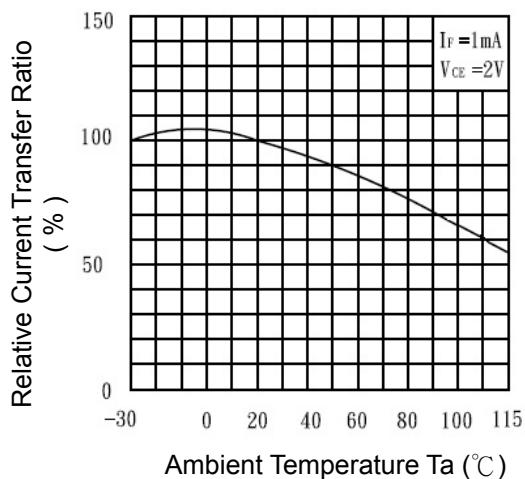


Collector-Emitter Saturation  
Voltage vs. Forward Current



### Relative Current Transfer

Ratio vs. Ambient  
Temperature



## ● NOTICE

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